

SPECIFICATION

FOR LCD MODULE

MODEL NO:	TM161FBCWVBYA
CUSTOMER:	
CUSTOMER P/N.	
VERSION	V1.0
CUSTOMER	
APPROVED	

□Preliminary specification

■Final specification

PREPARED BY	CHECKED BY	VERIFIED BY QA DEPT.	APPROVED BY

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REVISION RECORD

Version	Page	Revision Items	Name	Date
1.0		First release for new IC	KXH	2008.01.11

RoHS



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1 Description

The TM161FBCWVBYA, Character LCM unit consists of 16-character \times 1-line dot-matrix(5 \times 8 dot) LCD panel, LCD driver, controller LSI on a single PCB. Incorporating mask ROM-based character generator and display data RAM in the controller LSI, the unit can efficiently display the desired character under microprocessor control.

- Wide viewing direction.
- Wide Operating temperature.
- ◆ Requirements on environmental protection: RoHS.

2 Features

Item	Contents		
I CD tymo	STN		
LCD type	Positive		
LCD Duty	1/16		
LCD Bias	1/5		
Polarizer	Transflective		
LCD background color	Yellow-Green		
Segment color	Blue-Black		
Backlighting	LED		
Backlighting type	Edge		
Backlighting color	Yellow-Green		
Backlighting drive	200mA		
View direction	6:00 (wide view direction)		
Operating temperature	-20℃~+70℃		
Storage temperature	-30℃~ +80℃		
Controller	ST7066U		
Frame	SPCC (Black)		
Technology	СОВ		
Power supply	VDD=5.0V		
Data Transfer	8 Bit Parallel		

Notes:

- Color tone can slightly change with temperature and driving voltage.
- Color tone will be changed by backlight.



3 Absolute maximum ratings

(Without LED backlighting, Ta=25°C)

Parameter	Symbol	Min	Max	Unit	Remark
Logic circuit supply voltage	V _{CC}	-0.3	+7.0	V	
LCD driving voltage	V_{LCD}	VCC-10.0	VCC+0.3	V	
Operating temperature range	Тор	-20	+70	$^{\circ}$ C	No
Storage temperature range	Tst	-30	+80	$^{\circ}$	Condensation

Note:

- LCD operating voltage V_{LCD}=V_{CC} −V_{EE}
- If the module is above these absolute maximum ratings. It may become permanently damaged.
- V_{CC} >V_{SS} must be maintained.

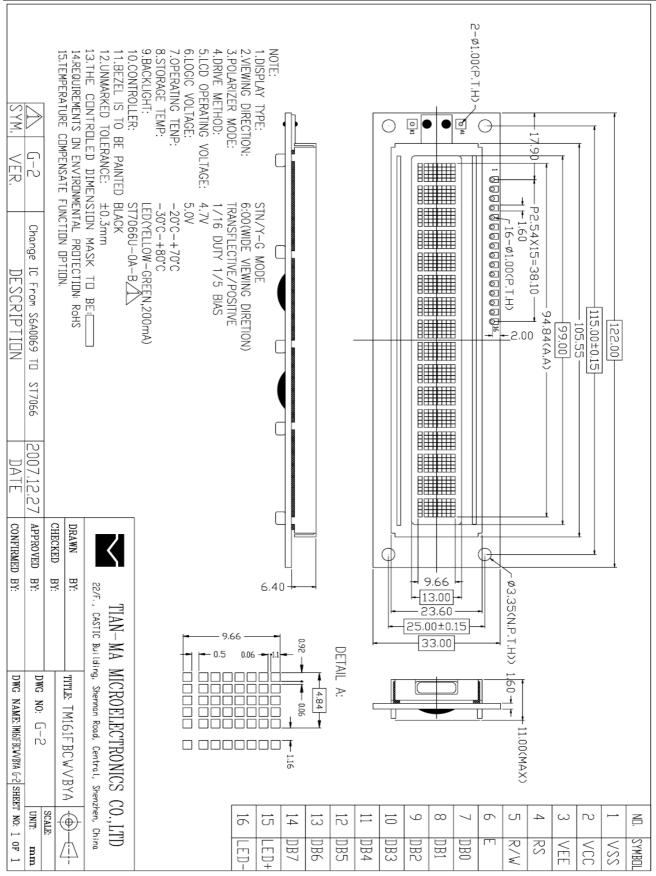
4 Mechanical Characteristics

4.1 Mechanical features

Parameter	Standard Value	Unit
Display type	Character Module	
Character size(W×H)	4.84×9.66	mm
Number of dots/characters (W×H)	16×1 (5×8)	
View area (W×H)	99.00 × 13.00	mm
Active Area (W×H)	94.84 × 9.66	mm
Dot Size (W×H)	0.92 × 1.1	mm
Dot Pitch (W×H)	0.98 × 1.16	mm
Module size(W×H×D)	$122.00 \times 33.00 \times 11.00(MAX)$	mm
Module total weight (approx)	35	g
Module outline dimensions	Refer to page 5-"Mechanical drawing"	

4.2 Mechanical drawing

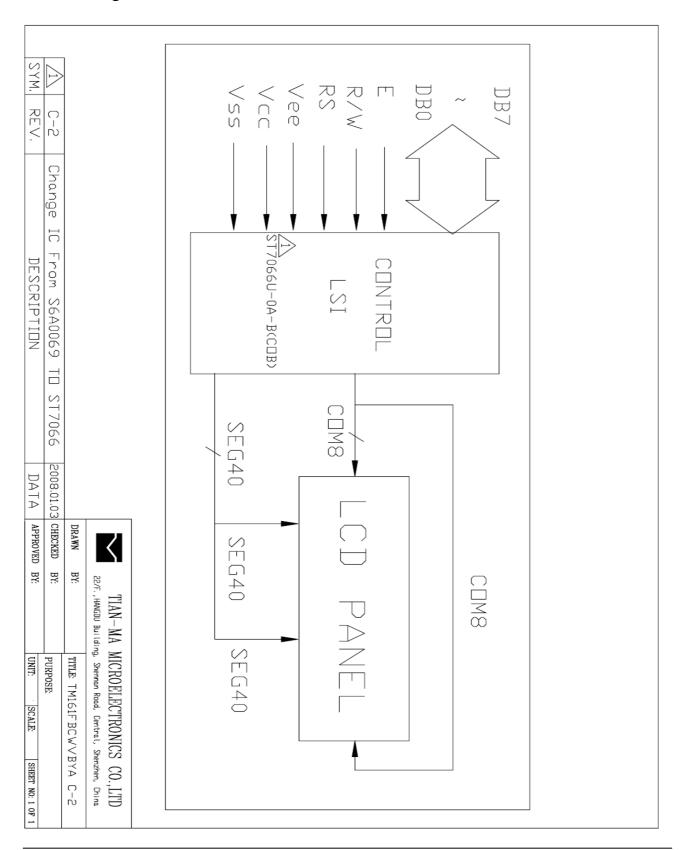






5 Circuit

5.1 Block Diagram



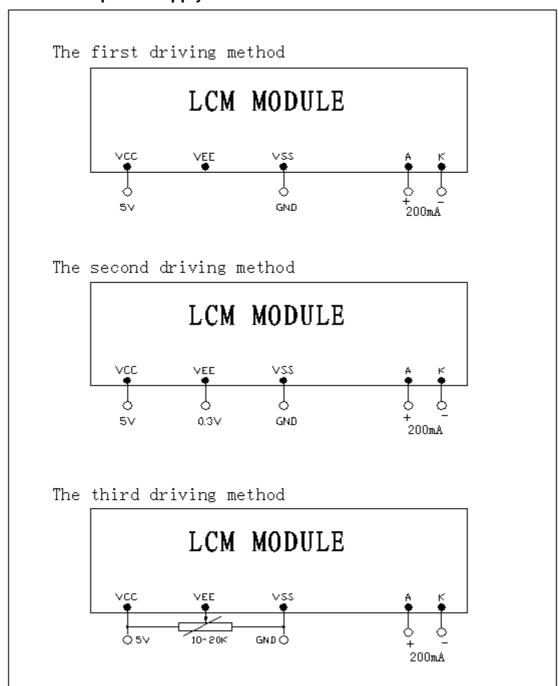
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5.2 Recommend power supply circuit



Note:

- You can control the contrast of module outside by add a VR (the third driving method, please remove R11 on PCB)
- You can use fixed current or 4.2VDC to drive the backlight



6 Interface description:

Pin No.	Symbol	I/O	Description
1	VSS	0V	Ground
2	VCC	5.0V	Power supply voltage for logic and LCD (+)
3	VEE	0.3V	Power supply voltage for LCD (-)
4	RS	I/O	Selects registers (H: Data L: Instruction)
5	R/W	I/O	Selects read or write
6	Е	I/O	Data read/write enable signal
7	DB0	I/O	Data bit0
8	DB1	I/O	Data bit1
9	DB2	I/O	Data bit2
10	DB3	I/O	Data bit3
11	DB4	I/O	Data bit4
12	DB5	I/O	Data bit5
13	DB6	I/O	Data bit6
14	DB7	I/O	Data bit7
15	LED+	200 4	Power supply voltage for LED (+)
16	LED-	200mA	Power supply voltage for LED (-)



7 Instruction Code & Timing characteristics

7.1 COMMAND

The module TM161FBCWVBYA includes the controller-ST7066U. The table below lists the types of commands, including the code of each command. More details refer to ST7066U data sheet please.

						and Co					to 0170000 data oncot ploat	Execution
Command	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Command Description	time (fsoc= 270kHz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM, and set DDRAM address to "00H" from AC.	1.52ms
Return Home	0	0	0	0	0	0	0	0	1	X	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.52ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Sets cursor move direction and specifies display shift. These operations are performed during data write and read.	37us
Display ON/OFF Control	0	0	0	0	0	0	1	D	С	В	D=1:entire display on C=1:cursor on B=1:cursor position on	37us
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	X	X	Set cursor moving and display shift control bit, and the direction, without changing DDRAM data.	37us
Function Set	0	0	0	0	1	DL	N	F	X	X	Set interface data length (DL : 4-bit/8-bit), numbers of display line (N : 1-line/2-line), display font type(F : 5 X 8 dots/ 5 X 11 dots)	37us
Set CGRAM Address	0	0	0	1	AC 5	AC 4	AC 3	AC 2	AC	AC 0	Set CGRAM address in address counter.	37us
Set DDRAM Address	0	0	1	AC 6	AC 5	AC 4	AC 3	AC 2	AC	AC 0	Set DDRAM address in address counter.	37us
Read Busy Flag and Address	0	1	BF	AC 6	AC 5	AC 4	AC 3	AC 2	AC 1	AC 0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	Ous
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	37ms
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	37ms

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Be sure the ST7066U is not in the busy state(BF=0) before sending an instruction from the MPU to the ST7066U.If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself. Refer to instruction Table for the list of each instruction execution time.

7.2 Interface Timing characteristics

Note: Please refer to IC: <u>ST7066U</u> data sheet for more details.

 $(VCC = 5V, TA = 25^{\circ}C)$

Mode	Characteristics	Symbol	Min	Тур	Max	Unit
	Enable Cycle Time	$T_{\rm C}$	1200	-	-	
	Enable Rise / Fall Time	T_R, T_F			25	
Write Mode	Enable Pulse Width	T_{PW}	140			
(refer to	Address Setup Time	T_{AS}	0			ns
Figure-1)	Address Hold Time	T_{AH}	10			
	Data Setup Time	T_{DSW}	40			
	Data Hold Time	T_{H}	10			

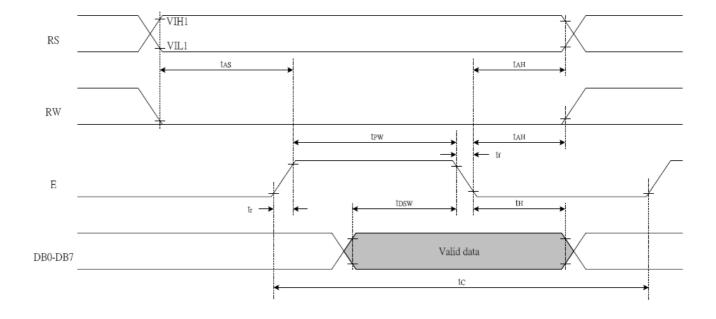


Figure 1: Write Mode Timing Diagram

(VCC =	5V,	Ta =	25℃)
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Mode	Characteristics	Symbol	Min	Тур	Max	Unit
	Enable Cycle Time	$T_{\rm C}$	1200			
	Enable Rise / Fall Time	T_R, T_F	1	1	25	
Read Mode	Enable Pulse Width	T_{PW}	140			
(refer to	Address Setup Time	T_{AS}	0			ns
Figure-2)	Address Hold Time	T_{AH}	10			
	Data Setup Time	T_{DDR}	-		100	
	Data Hold Time	T_{H}	10			

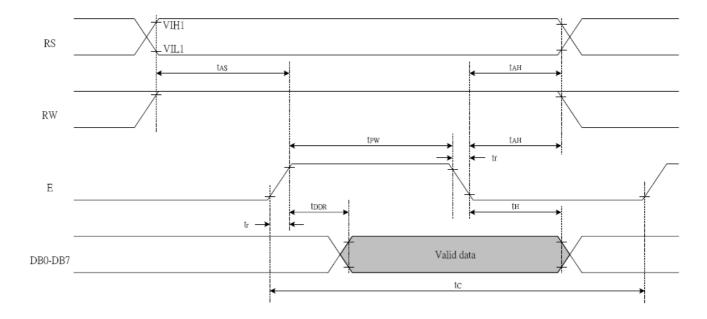


Figure2: Read Mode Timing Diagram



7.3 character generator code map (Please refer to ST7066U datasheet for other character code map)

67-64 63-60	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
	CG RAM (*)													***		
0001	(2)															
0010	(3)															
0011	(4)															**
0100	(5)															
0101	(6)															
0110	(7)															
0111	(8)															
1000	(1)															
1001	(2)															
1010	(3)															*
1011	(4)															
1100	(5)															
1101	(6)															
1110	(7)															
1111	(8)															

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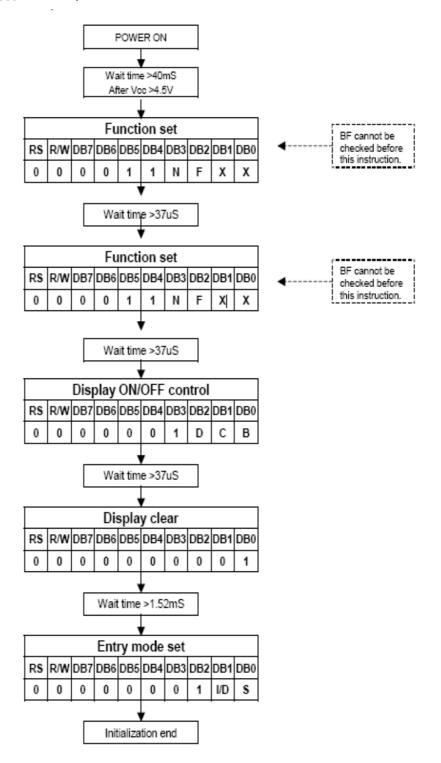
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7.4 Initialization flow map

(For 8-Bit Interface F_{OSC}=270KHz)



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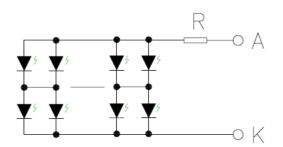
8 Electrical characteristics

 $V_{CC}=5.0V$, $V_{SS}=0V$, Ta=25°C

Parameter	Symbol	Condition	MIN	TYP	MAX	UNIT		
Logic circuit supply voltage		V _{CC}		4.8	5.0	5.2		
Power supply LCD		V _{LCD}	VCC-V5	4.4	4.7	5.0		
Input voltage for logic	"H"level	V _{IH}		0.7V _{CC}		V _{CC}	V	
circuit	"L"level	V _{IL}		-0.3		0.6	V	
Output voltage for	"H"level	V _{OH}	I _{OH} =-0.1mA	3.9				
logic circuit	"L"level	V _{OL}	I _{OL} =0.1mA			0.4		
Logic power supply current (Without backlighting)		Icc	F _{OSC} =270KHz VCC=5.0V		0.5	2.0	mA	
Used driver IC		ST7066U OF SITRONIX						

9 LED backlight characteristics

Ta=25°C



CIRCUIT DIAGRAM (LED 2X20=40 dies)

Item	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Forward voltage	V_{f}	I _f =200mA	4.0	4.2	4.4	٧
Luminous intensity*	Вр		120	180		cd/m ²
Luminous Uniformity*	△Вр	I _f =200mA	70			%
Peak Wave length	λр		569	572	575	nm

Note:

- Measured at the bare LED backlight unit.
- If the backlight is above these maximum ratings for long time, the service life of the LED backlight will reduce or it will cause poor reliability.

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10 Optical Characteristics

10.1 Optical Characteristics

Ta=25

Doron	motor	Cymphol		Ratings		l loit	Measuring	Deference	
Parar	neter	Symbol	Min	Type	Max.	Unit	Temp.	Reference	
Operating voltage		V _o	4.4	4.7	5.0	V	25		
Frame from	equency	f		70		Hz	25	(Note10-2)	
Contra	st ratio	Cr(θ=20°, Φ=90° or 270°)		10			25	(Note10-3)	
	Turn on	+			250	ma	25		
Response	Turrion	t _{on}				ms	1113	0	(Note10-4)
time	Turn off	+			250	ma	25	(Note 10-4)	
	Turrion	t_{off}				ms	0		
Viewing	Up-down	<i>θ</i> 1 (<i>Φ</i> =90° or 270°)		-50-60		deg	25	(N-1-10 E)	
angle (Cr≥2)	Left-right	<i>θ</i> 2 (<i>Φ</i> =0° or 180°)		-35-40		deg	25 ℃	(Note10-5)	

(Note10-1) The maximum and minimum ratings don't mean the LCD works well in the whole range of Vo. Vo must be adjusted to optimize the viewing angle and contrast. Refer to definition of drive voltage, refer to 10.2.

(Note10-2) The frequency shouldn't be too low to avoid flicker. Refer to definition of drive voltage, refer to 10.2.

(Note10-3) Refer to 10.2/10.3/10.4/10.5.

(Note10-4) The selected state is dark and non-selected state is white (or bright) with positive type, reversely the selected state is white (or bright) and non-selected state is dark with negative type. Refer to 10.6 definition of response time.

(Note10-5) Generally the viewing direction is 6:00 or12:00, sometimes 3:00 or 9:00. The range of left to right and up to down based on Cr=2 show the viewing angle. Viewing angle range isn't the range of defects inspection. Refer to 10.4.



10.2 Definition of drive voltage

(1) Definition of drive voltage and waveform

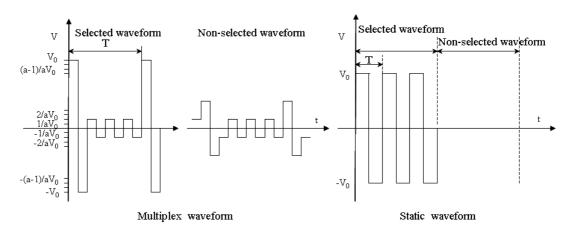


Fig.1 Definition of drive voltage and waveform

Operating voltage: V_o Frame frequency: f=1/T

Duty: 1/N Bias: 1/a

(2) Operating voltage: Vo

TIANMA can evaluate whether the LCD can be redesigned to obtain customer preferable performance if customer's LCD drive voltage isn't adjustable.

10.3 Optical characteristics measurement equipment and method

The setup and test method are showed in fig.2. Test methods are different according to different illumination mode.

Transmissive mode: light resource is placed at the back of LCD.

Reflective mode and transflective mode: light resource is placed at the front side of LCD.

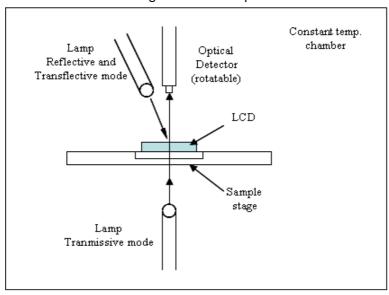


Fig.2 Optical characteristics measurement equipment

30F



The chamber temperature, light resource and driving signal should be stable before testing. If test the characteristics under high or low temperature, the test system should be stable for more than 10 minutes before testing.

10.4 Definition of viewing direction

Refer to the graph below marked by θ and Φ

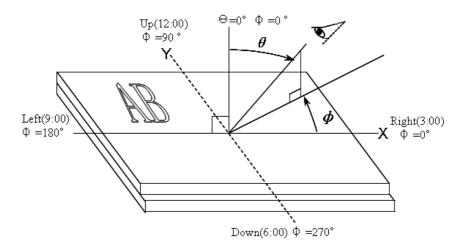


Fig.3 Definition of viewing direction

10.5 Definition of contrast ratio

Contrast ratio can be calculated by the formula (10-1) below for positive type. If the LCD is negative type, $Cr(\theta, \Phi)$ is equal to luminance $(\theta, \Phi, \text{non-selected state})$ divided by luminance $(\theta, \Phi, \text{selected state})$. Note3-4 shows the relationship between selected state, non-selected state and bright state, dark state.

$$\operatorname{Cr}(\theta, \phi) = \frac{L_2}{L_1} = \frac{\operatorname{Luminance}(\theta, \phi) \text{ (Bright state)}}{\operatorname{Luminance}(\theta, \phi) \text{ (Dark state)}}$$
(10-1)

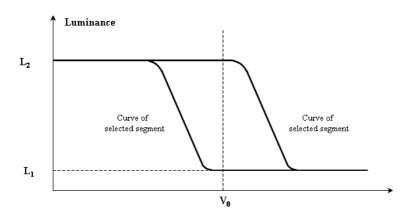


Fig.4 Electro-optical characteristic (EOC) graph (positive type)

10.6 Definition of response time

Turn on time (rise time): $t_{on} = t_d + t_r$ (from non-selected state to selected state)

 \mathbf{SOL}

Turn off time (fall time): $t_{off}=t_D+t_R$ (from selected state to non-selected state)

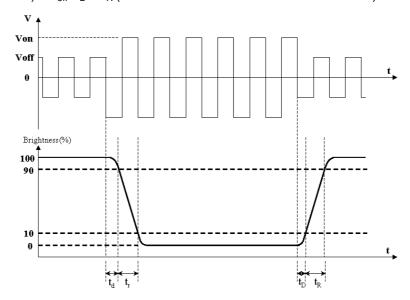


Fig.5 Definition of response time (positive type)

10.7 Definition of viewing angle

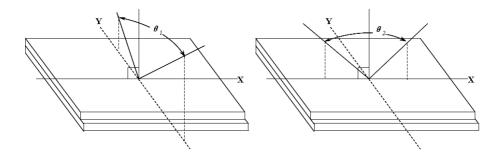


Fig 6 Definition of viewing angle

 θ_1 ——range of viewing angle from up to down

 θ_2 ——range of viewing angle from left to right.



11 Reliability

11.1 Content of Reliability Test

Ta=25

	<u> </u>					
No	Test Item	Test condition	Criterion			
1	High Temperature Storage	80℃±2℃ 120H Restore 2H at 25℃ Power off				
2	Low Temperature Storage	-30°C±2°C 120H Restore 2H at 25°C Power off				
3	High Temperature Operation	70℃±2℃ 120H Restore 2H at 25℃ Power on				
4	Low Temperature Operation	-20℃±2℃ 120H				
5	High Temperature & Humidity Operation	40℃±2℃ 90%RH 120H Power on	and electrical defects should not happen.			
6	Temperature Cycle	-30°C →25°C →80°C 30min 5min 30min after 10cycle, Restore 2H at 25°C Power off				
7	Vibration Test	10Hz~150Hz, 100m/s², 120min				
8	Shock Test	Half-sine wave,300m/s ² ,11ms				
9	Drop Test(package state)	800mm, concrete floor,1corner, 3edges, 6 sides each time	1.After testing, cosmetic and electrical defects should not happen. 2.the product should remain at initial place 3.Product uncovered or package broken is not permitted.			

Notes:

1. Each test item applies for a test sample only once, The test sample can not be used again in any other test item.

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- 2. The test sample is inspected after 2 hours or more storing at room temperature and room humidity after each test item is finished.
- 3. The criteria refer to 11.2.

11.2 Inspection of criteria

Remark NO.	Content
1	Functional test is OK. Missing Segment, shorts, unclear segment, non-display, display abnormally, liquid crystal leak are unallowable.
2	After testing, cosmetic defects should not happen, no low temperature bubbles, seal loose and fall, frame rainbow, ACF bubble growing are unallowable in the appearance test.
3	Total current consumption should not be over 10% of initial value.
4	After tests being executed, Contrast must be larger than 70% of its initial value prior to the tests.
5	No glass crack, chipped glass, end seal loose frame crack and so on.
6	No structure loose and fall.



12 Quality level

12.1 Classification of defects

Major defects (MA): A major defect refers to a defect that may substantially degrade usability for product applications, including all functional defects (such as no display, abnormal display, open or missing segment, short circuit, missing component), outline dimension beyond the drawing, progressive defects and those affecting reliability.

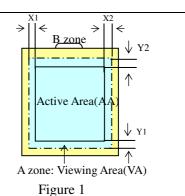
Minor defects (MI): A minor defect refers to a defect which is not considered to be able to substantially degrade the product application or a defect that deviates from existing standards almost unrelated to the effective use of the product or its operation, such as black spot, white spot, bright spot, pinhole, black line, white line, contrast variation, glass defect, polarizer defect, etc.

12.2 Definition of inspection range

For LCD defects, dividing two areas to make a judgment (according figure 1).

A zone : Inside Viewing area B zone : Outside Viewing area

X1(A.A~V.A): 2mm X2(A.A~V.A): 2mm Y1(A.A~V.A): 2mm Y2(A.A~V.A): 2mm



12.3 Inspection items and general notes

1210 mopo	12.5 mapection items and general notes							
General notes	Should any defects which are not specified in this standard happen, additional standard shall be determined by mutual agreement between customer and TIANMA. Viewing area should be the area which TIANMA guarantees. Limit sample should be prior to this Inspection standard. Viewing judgment should be under static pattern. Inspection conditions Inspection distance: 250 mm (from the sample) Temperature : 25±5 °C Inspection angle : 45 degrees in 12 o'clock direction (all defects in viewing area should be inspected from this direction)							
	Pinhole, Bright spot, Black spot, White spot, Black line, White Line, Foreign particle, Bubble	The color of a small area is different from the remainder. The phenomenon doesn't change with voltage						
	Contrast variation	The color of a small area is different from the remainder. The phenomenon changes with voltage						
Inspection items	Polarizer defect	Scratch, Dirt, Particle, Bubble on polarizer or between polarizer and glass						
	Functional defect	no display, display abnormally, open or missing segment, short circuit, False viewing direction						
	Glass defect	Glass crack, Shaved corner of glass, Surplus glass						
	Segment defect	Pin holes or cracks in segment, Transformation of segment						
	PCB defect	Components assembly defect						

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12.4 Outgoing Inspection level

	·						
Outgoing Inspection	Inconcion conditions		Inspection				
standard	Inspection conditions		Max.	Unit	⊒	AQL	
Major Defects	Major Defects See 13.3 general notes					0.65	
Minor Defects See 13.3 general notes See 13.5 II 1.5					1.5		
Note: Sampling standa	rd conforms to GB2828						

12.5 Inspection Items and Criteria

				Judgment standard						
	Inspection	on items		Category	Acceptable r	umber				
	,			Calegory	A zone	B zone				
	Black spot, white spot, Bright Spot,			Ф≦0.10	Neglected					
1	Pinhole, Foreign Particle, Particle in			0.10<Φ≦0.20	3	Neglected				
	Scratch on glass	Φ=(a+b)/2(m	С	0.20<Ф	0					
	Black line, White	4	Α	W≦0.02	Neglected					
2	line, Particle Between Polarizer and glass, Scratch		В	0.02 <w 0.05<br="" ≤="">L ≤ 3.0</w>	3	Neglected				
	on glass	L:Length(mm)	С	W>0.05 or L>3.0	0					
		<u> </u>	Α	Ф≦0.2	Neglected					
		riation a	В	0.2<Φ≦0.3	2	Neglecte				
3	Contrast variation		С	0.3<Φ≦0.4	1	d				
		$\Phi = (a+b)/2(mm)$		0.4<Ф	0					
			То	tal defective point(B,C)	3					
4	Bubble inside cell			any size	none	none				
	Scratch ,damage or polarizer, Particle or polarizer or betweer polarizer and glass. Polarizer defect (if		Ref	fer to item 1 and item 2.						
5	Polarizer is used)			Ф≦0.3	Neglected					
		convex	В	0.3<Φ≦0.7	2	Neglecte				
			С	0.7<Ф	0	_ d				

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	Complete	Stage surplus glass	b≦0.3mm					
6	Surplus glass	Surrounding surplus glass	Should not influence outline dimension and assembling.					
7	Open segment or op	pen common	Not permitted					
8	Short circuit		Not permitted					
9	False viewing direct	ion	Not permitted					
10	Contrast ratio uneve	en	According to the limit	specimen				
11	Crosstalk		According to the limit	specimen				
12	Black /White spot(di	splay)	Refer to item 1					
13	Black /White line(dis	splay)	Refer to item 2					
14		- - a	not counted	Max.3 dots allowed	Max.3			
	Pin holes and		x<0.1mm	0.1mm≤x≤0.2mm				
	cracks in segment	a-1 F-	X=(dots				
		-D	not counted	Max.2 dots allowed each segment	allowed			
			A<0.1mm	0.1mm≤A≤0.2mm D<0.25mm				
15	Transformation of segment		not counted	Max.1 defect allowed each segment				
		'	x<0.1mm	0.1mm≤x≤0.2mm				
			X=	Max.3 defects				
	D-++a		not counted	Max.1 defect allowed each segment	allowed			
			a<0.1mm	0.1mm≤a≤0.2mm D>0				





0.8W≤a≤1.2W a=measured value of width W=nominal value of width

Max.2 defects allowed

				Judgment standard	
		Inspection items		Category(application: B zone)	Acceptable number
		The front of lead terminals	В	a≤ t, b≤1/5W, c≤3mm Crack at two sides of lead terminals should not cover patterns and alignment mark	
16	Glass defect crack	②Surrounding crack—non-contact side seal c h a t c h a Inner border line of the seal Outer border line of the seal	b < Inner borderline of the seal		Max.3 defects allowed
		3 Surrounding crack— contact side seal c b a Inner border line of the seal Outer border line of the seal	b «	< Outer borderline of the seal	

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(④Corner	Α	a t, b 3.0, c 3.0
	w b c	В	Glass crack should not cover patterns u and alignment mark and patterns.

		Inspection items	Judgment standard		
		inspection items	Category(application: B zone)		
17	PCB defect	Component soldering: No cold soldering, short, open circuit, burr, tin ball The flat encapsulation component position deviation must be less than 1/3 width of the pin (Pic.1); the sheet component deviation: Pin deviates from the pad and contact with the near components is not permitted (Pic.2) lead defect: The lead lack must be less than 1/3 of its width; The lead burr must be less than 1/3 of the seam; Impurities connect with the near leads is not permitted	Component Soldering pad Lead L1>0 L2>0		

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V	Micro electron	uies Co.,LTD	WODULE NOIWITOTFBGWVBTA VI.U
	Sold plug	nector soldering: ering tin is at contact position of the and socket is not permitted bundation is scald	head Base Board Soldering tin is not permit in this area
		ous cave distortion on plug and et contact pin is not permitted	Soldering tin is not permit in this area
			socket Base Board
	moto The into	on root of the speaker receiver and or lead: insulative coat of the lead must join the PCB; the protected glue must lop to the insulative coat.	Glue



13 Precautions for Use of LCD Modules

13.1 Handling Precautions

- 13.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 13.1.2 Liquid in LCD is hazardous substance, if the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, thoroughly and promptly wash it off using soap and water.
- 13.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 13.1.4 Don't touch, push or rub the exposed polarizer covering the display surface of the LCD module with anything harder than an HB pencil lead, the polarizer is soft and easily scratched, handle it carefully.
- 13.1.5 Don't put or attach anything on the display area to avoid leaving any marks on.
- 13.1.6 If the display surface is contaminated or becomes dusty, breathe on the surface and gently wipe it with a soft dry cloth. do not scrub hard to avoid damage the surface. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 13.1.7 Do not attempt to disassemble the LCD Module.
- 13.1.8 If the logic circuit power is off, do not apply the input signals.
- 13.1.9 Avoid using the same display pattern long time (continuous ON segment). Software must be prepared so that the pattern will be changed
- 13.1.10 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body and electric appliances when handling the LCD Modules. It is preferable to use conductive mat on table and wear cotton clothes or conductive processed fibre. Synthetic fibre is not recommended.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.
 - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - d. The LCD Module is coated with a film to protect the display surface. Be careful and slow when peeling off this protective film since static electricity may be generated. It is recommended to use ionic fan or machine when operating. It is recommended to remove the protection foil slowly (> 3 sec.).
 - e. It is preferable to wear gloves etc, to avoid damaging the LCD. Please do not touch electrodes with bare hands or avoid any other contamination.



13.2 Storage precautions

- 13.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 13.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 5 \sim 40 Relatively humidity: \leq 80%

- 13.2.3 The LCD modules should be stored in a clean environment or room, free from acid, alkali and harmful gas.
- 13.2.4 Store the module in anti-static electricity container and without any physical load.

13.3 Transportation precautions

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

13.4 Soldering

- 13.4.1 Use the high quality solders, only solder the I/O terminals.
- 13.4.2 No higher than 280 and time less than 3-4 second during soldering.
- 13.4.3 Rewiring: no more than 3 times.
- 13.4.4 when you remove connector or cable soldered to I/O terminals, please confirm that solder is fully melted. If you remove by force, electrodes at I/O terminals may be damaged (or stripped off). It is recommended to use solder suction machine.

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14. LCD Module Part Numbering System

	TM	161	F	В	C	W	V	В	Y	A
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1 2 3 4 5 6 7 8 9 0		_	_	_	_	_	_	_	_	_
(1) (2) (3) (4) (5) (6) (7) (8) (9) (1	`							\sim	\sim	400
)	(ソ)	(3)	(/1)	(5)	(6)	('7)	(Q)	(u)	(10)
	,	(2)	(0)	(/	(U)	(U)	(1)	(0)	(3)	(10)

NO.	Explanation								
1	TIANMA module indicating								
2	Modu	le type: 3 DIGITS, 16-Character × 1-Line,							
3	TIANMA module series (A,B,C,D)								
4	LCD type								
4)	В	Positive, Yellow-Green mode, STN							
(5)	Backlight type								
9	С	Transflective, LED							
6	Temperature range								
0	W	Wide temperature							
(7)	Viewi	ng Angle							
	V	Wide viewing direction							
8	Techr	nology							
	В	COB (including SMT)							
9	The color of backlight								
9)	Υ	Yellow-green							
(10)	Funct	ion choice							
(10)	Α	Without any function							

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